

AMP-LATCH | AMP-LATCH Universal Headers

TE Internal #: 102153-4

Board-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Vertical, Through Hole - Solder, 2 Row, AMP-LATCH Universal Headers,

Ribbon Cable Connectors

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Connector System: Board-to-Board

Number of Positions: 20

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without

PCB Mount Retention Type: Screw Mount

All AMP-LATCH UNIVERSAL HEADERS (523)

Features

Product Type Features

| Connector Product Type | Connector Assembly |
|------------------------------------|--------------------------------|
| Ribbon Cable Connector Header Type | Universal Ejection Pin Headers |
| Connector System | Board-to-Board |
| Connector & Housing Type | Receptacle |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Number of Positions | 20 |
|-----------------------|----------|
| PCB Mount Orientation | Vertical |
| Number of Rows | 2 |

Electrical Characteristics

| Operating Voltage | 250 VAC |
|-----------------------|---------|
| Insulation Resistance | 5000 MΩ |



Body Features

| Daisy Chain | Without |
|-----------------------|----------|
| Primary Product Color | Black |
| Connector Profile | Standard |

Contact Features

| Contact Underplating Material | Nickel |
|---|---|
| | 15 μin |
| Mating Square Post Dimension | .64 mm[.025 in] |
| Contact Shape & Form | Square |
| PCB Contact Termination Area Plating Material Thickness | 2.54 μm[100 μin] |
| Contact Mating Area Plating Material | Gold (Au), Gold Flash over Palladium Nickel |
| Contact Base Material | Brass, Phosphor Bronze |
| PCB Contact Termination Area Plating Material | Tin-Lead |
| Contact Type | Pin |
| Contact Current Rating (Max) | 1 A |

Termination Features

| Termination Post & Tail Diameter | .64 mm[.025 in] |
|----------------------------------|-----------------------|
| Termination Post & Tail Length | 2.79 mm[.11 in] |
| Termination Method to PCB | Through Hole - Solder |

Mechanical Attachment

| Panel Mount Feature | Without |
|--------------------------|-----------------------------|
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| PCB Mount Retention Type | Screw Mount |
| Mating Alignment Type | Center, Dual Polarizing Bar |
| Mating Retention | Without |
| Connector Mounting Type | Board Mount |

Housing Features

| Housing Material | Thermoplastic |
|--------------------|----------------|
| Centerline (Pitch) | 2.54 mm[.1 in] |

Dimensions



| Shrouded End Dimension | 3.81 mm[.15 in] |
|-----------------------------|------------------|
| PCB Thickness (Recommended) | 1.57 mm[.062 in] |
| Connector Height | 13.94 mm[.55 in] |
| Row-to-Row Spacing | 2.54 mm[.1 in] |

Usage Conditions

| Housing Temperature Rating | Standard |
|-----------------------------|----------------------------|
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |

Operation/Application

| Solder Process Feature | Solder Dipped |
|------------------------|---------------|
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |

Packaging Features

| Packaging Quantity | 70 |
|--------------------|------|
| Packaging Method | Tray |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Not Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant with Exemptions |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (13% in 4690948374) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

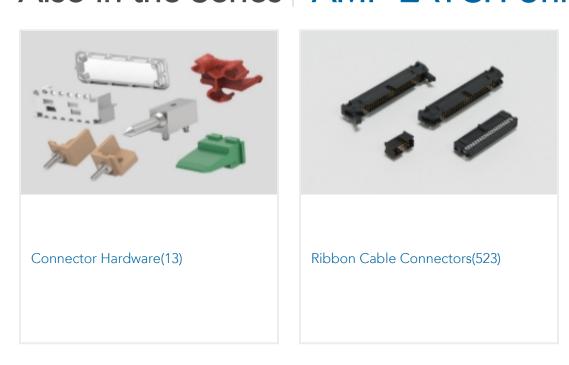


chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMP-LATCH Universal Headers



Customers Also Bought























Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_102153-4_M.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_102153-4_M.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_102153-4_M.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

AMP INSTALLATION PROCEDURES FOR AMP-LATCH UNIVERSAL HEADER ASSEMBLIE

English

Agency Approvals

Agency Approval Document

English

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